

DESCRIPTION

2SA1948 is a resin sealed silicon PNP epitaxial type transistor. It is designed with high voltage, high h_{FE} and high f_r .

Complementary with 2SC5213.

FEATURE

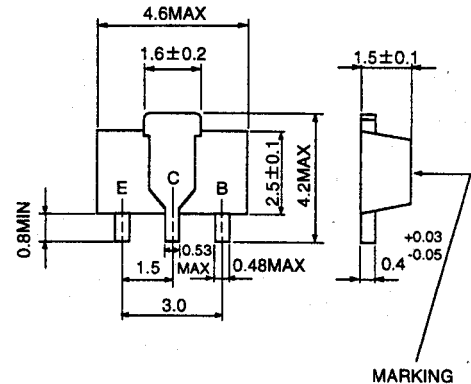
- High f_r $f_r=200\text{MHz}$ typ, low C_{ob} $C_{ob}=3.5\text{pF}$ typ
- Excellent linearity of DC forward current gain
- High h_{FE} $h_{FE}=150$ to 800
- Small package for mounting
- High voltage $V_{CE0}=120\text{V}$
- High collector dissipation $P_c=500\text{mW}$

APPLICATION

Pre-drive stage of output 40 to 80W main amplifier. Final stage of tone control amplifier.

OUTLINE DRAWING

Unit:mm

**TERMINAL CONNECTOR**

E : EMITTER
C : COLLECTOR
B : BASE

EIAJ : SC-62
JEDEC : -

Note)

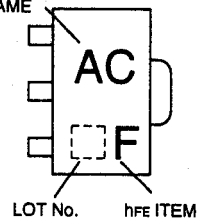
The dimension without tolerance represent central value.

MAXIMUM RATINGS ($T_a=25^\circ\text{C}$)

Symbol	Parameter	Rating	Unit
V_{CBO}	Collector to Base voltage	-120	V
V_{EBO}	Emitter to Base voltage	-5	V
V_{CEO}	Collector to Emitter voltage	-120	V
I_C	Collector current	-100	mA
P_c	Collector dissipation($T_a=25^\circ\text{C}$)	500	mW
T_j	Junction temperature	+150	$^\circ\text{C}$
T_{stg}	Storage temperature	-55 to +150	$^\circ\text{C}$

MARKING

TYPE NAME



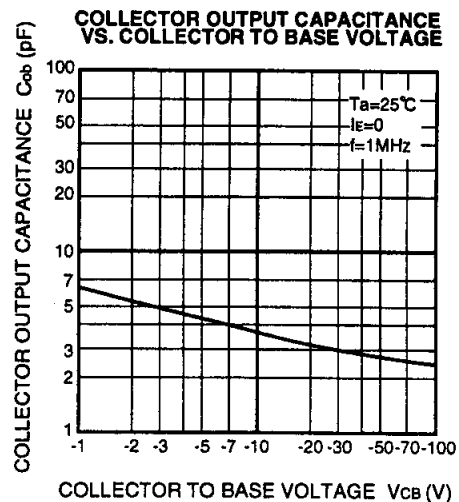
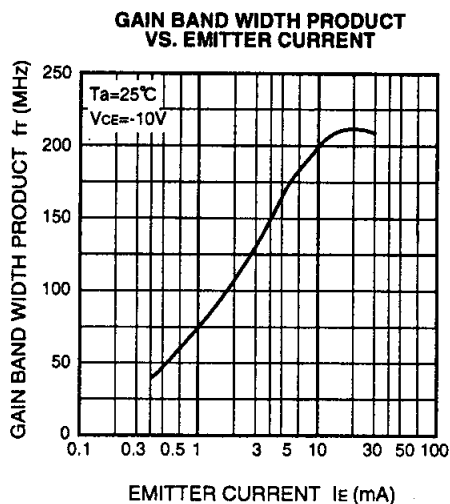
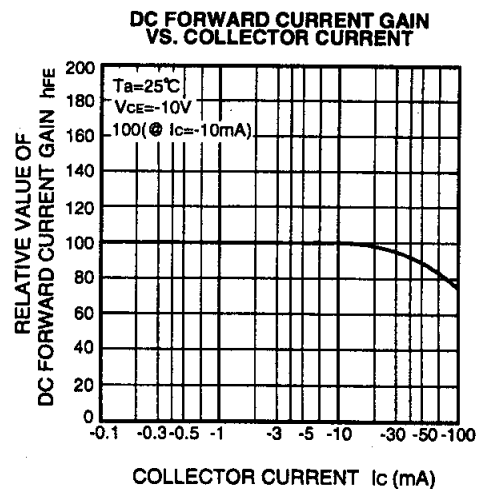
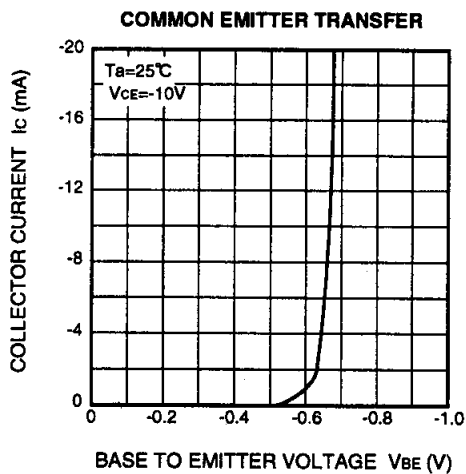
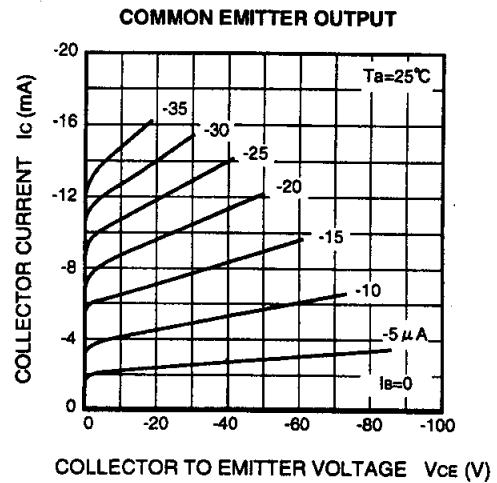
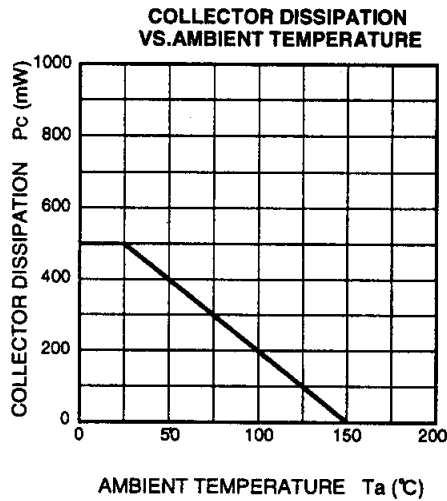
LOT No. hFE ITEM

ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$)

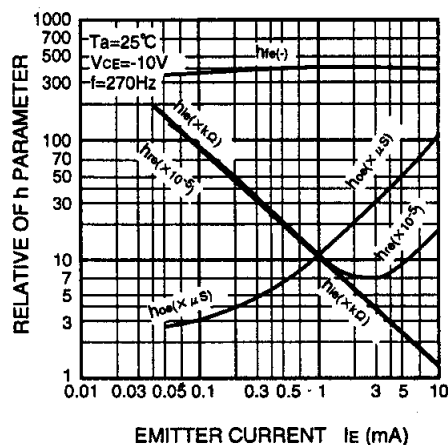
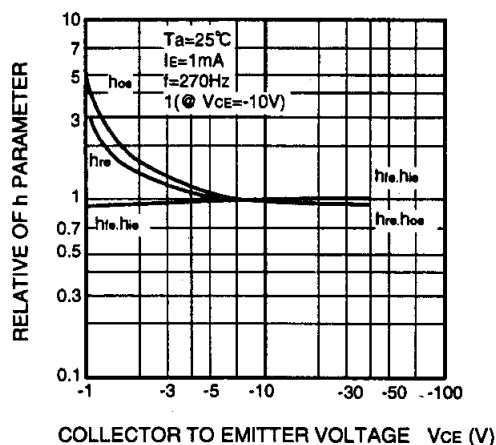
Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$V_{(BR)CBO}$	C to B break down voltage	$I_C=-10\mu\text{A}, I_E=0$	-120			V
$V_{(BR)EBO}$	E to B break down voltage	$I_E=-10\mu\text{A}, I_C=0$	-5			V
$V_{(BR)CEO}$	C to E break down voltage	$I_C=-1\text{mA}, R_{BE}=\infty$	-120			V
I_{CBO}	Collector cut off current	$V_{CB}=-100\text{V}, I_E=0$			-0.1	μA
I_{EBO}	Emitter cut off current	$V_{BE}=-4\text{V}, I_C=0$			-0.1	μA
h_{FE}^*	DC forward current gain	$V_{CE}=-10\text{V}, I_C=-10\text{mA}$	150		800	—
$V_{CE(sat)}$	C to E saturation voltage	$I_C=-50\text{mA}, I_E=-2.5\text{mA}$		-0.17	-0.6	V
f_r	Gain band width product	$V_{CE}=-10\text{V}, I_E=10\text{mA}$		200		MHz
C_{ob}	Collector output capacitance	$V_{CB}=-10\text{V}, I_E=0, f=1\text{MHz}$		3.5		pF

* : It shows h_{FE} classification in right table.

Marking	ACE	ACF	ACG
h_{FE}	150 to 300	250 to 500	400 to 800

FOR PRE-DRIVE APPLICATION
SILICON PNP EPITAXIAL TYPE**TYPICAL CHARACTERISTICS**

**FOR PRE-DRIVE APPLICATION
SILICON PNP EPITAXIAL TYPE**

h PARAMETER VS. EMITTER CURRENT**h PARAMETER VS. COLLECTOR TO EMITTER VOLTAGE****COMMON EMITTER h PARAMETER (TYPICAL VALUE)**

Symbol	Parameter	Test conditions	Limits	Unit
h_{ie}	Closed loop small signal input impedance	$T_a = 25^\circ\text{C}$ $V_{CE} = -10\text{V}$ $I_E = 1\text{mA}$ $f = 270\text{Hz}$	10.8	$\text{k}\Omega$
h_{re}	Open loop small signal reverse voltage amplification factor		1.16	$\times 10^{-4}$
h_{fe}	Closed loop small signal forward current amplification factor		400	—
h_{oe}	Open loop small signal output admittance		11.2	μS



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